

OSD3358-512M-BSM Information


For Reference Only

Part Number [OSD3358-512M-BSM](#)
Manufacturer Octavo Systems LLC
Category Integrated Circuits (ICs)
[Embedded - Microcontroller, Microprocessor, FPGA Modules](#)
Description 21MM 256 BALL BGA
Package -
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


OSD3358-512M-BSM Specifications

Manufacturer Part Number	OSD3358-512M-BSM
Manufacturer	Octavo Systems LLC
Category	Integrated Circuits (ICs) Embedded - Microcontroller, Microprocessor, FPGA Modules
Package	-
Series	OSD335x
Module/Board Type	MPU Core
Core Processor	ARM® Cortex®-A8, AM3358
Co-Processor	NEON™ SIMD
Speed	1GHz
Flash Size	-
RAM Size	512MB
Connector Type	256-BGA
Size / Dimension	0.83" x 0.83" (21mm x 21mm)
Operating Temperature	0°C ~ 85°C

[Report errors?](#)

OSD3358-512M-BSM Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

OSD3358-512M-BSM Payment Methods



OSD3358-512M-BSM Shipping Methods



If you have any question about OSD3358-512M-BSM, please do not hesitate to contact us!

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